Dual 4-input NAND buffer   74F40

TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F40	3.5ns	6mA

ORDERING INFORMATION

DESCRIPTION	COMMERCIAL RANGE V_{CC} = 5V ±10%, T_{amb} = 0°C to +70°C
14-pin plastic DIP	N74F40N
14-pin plastic SO	N74F40D

PIN CONFIGURATION

D0a 1	14 V_{CC}
D0b 2	13 D1d
NC 3	12 D1c
D0c 4	11 NC
D0d 5	10 D1b
$\overline{Q}0$ 6	9 D1a
GND 7	8 $\overline{Q}1$
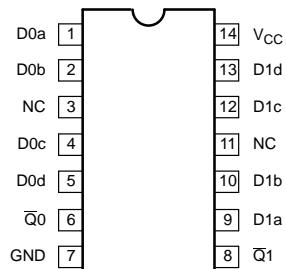
SF00065

INPUT AND OUTPUT LOADING AND FAN OUT TABLE

PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
Dna, Dnb, Dnc, Dnd	Data inputs	1.0/2.0	20µA/1.2mA
$\overline{Q}0$, $\overline{Q}1$	Data outputs	750/106.7	15mA/64mA

NOTE: One (1.0) FAST unit load is defined as: 20µA in the High state and 0.6mA in the Low state.

LOGIC DIAGRAM

V_{CC} = Pin 14
GND = Pin 7
NC = Pin 3, 11

SF00081
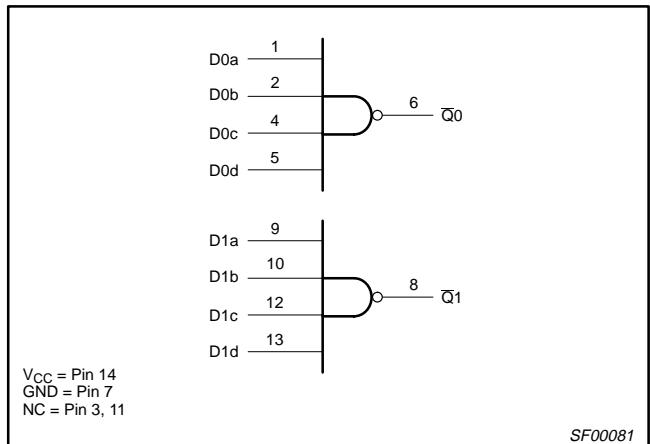
FUNCTION TABLE

INPUTS				OUTPUT
Dna	**Dnb**	**Dnc**	**Dnd**	**$\overline{Q}n$**
L	X	X	X	H
X	L	X	X	H
X	X	L	X	H
X	X	X	X	H
H	H	H	H	L

NOTES:
1. H = High voltage level
2. L = Low voltage level
3. X = Don't care

LOGIC SYMBOL

V_{CC} = Pin 14
GND = Pin 7
NC = Pin 3, 11

SF00082

IEC/IEEE SYMBOL

SF00083
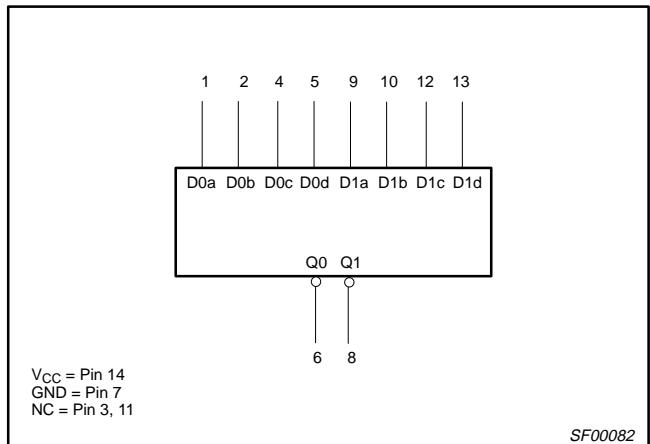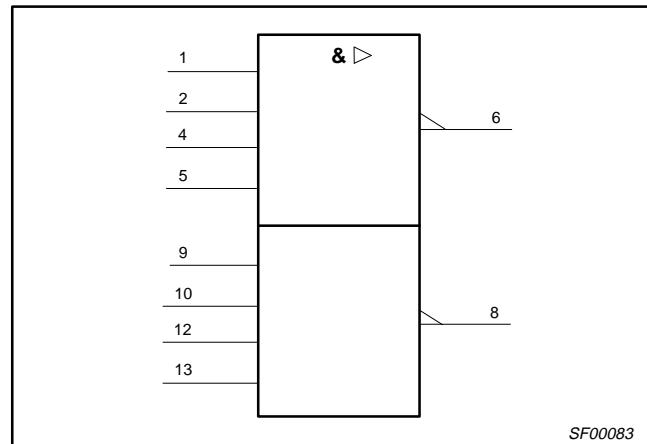
Dual 4-input NAND buffer

74F40

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limits set forth in this table may impair the useful life of the device.
Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V_{CC}	Supply voltage	−0.5 to +7.0	V
V_{IN}	Input voltage	−0.5 to +7.0	V
I_{IN}	Input current	−30 to +5	mA
V_{OUT}	Voltage applied to output in High output state	−0.5 to V_{CC}	V
I_{OUT}	Current applied to output in Low output state	128	mA
T_{amb}	Operating free-air temperature range	0 to +70	°C
T_{stg}	Storage temperature range	−65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS			UNIT
		MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5.0	5.5	V
V_{IH}	High-level input voltage	2.0			V
V_{IL}	Low-level input voltage			0.8	V
I_{IK}	Input clamp current			−18	mA
I_{OH}	High-level output current			−15	mA
I_{OL}	Low-level output current			64	mA
T_{amb}	Operating free-air temperature range	0		+70	°C

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER	TEST CONDITIONS[1]			LIMITS			UNIT
					MIN	TYP[2]	MAX	
V_{OH}	High-level output voltage	V_{CC} = MIN, V_{IL} = MAX, V_{IH} = MIN	I_{OH} = −1mA	±10%V_{CC}	2.5			V
				±5%V_{CC}	2.7	3.4		
			I_{OH} = −15mA	±10%V_{CC}	2.0			V
				±5%V_{CC}	2.0			
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IL} = MAX, V_{IH} = MIN	I_{OL} = MAX	±10%V_{CC}			0.55	V
				±5%V_{CC}		0.42	0.55	
V_{IK}	Input clamp voltage	V_{CC} = MIN, I_I = I_{IK}				−0.73	−1.2	V
I_I	Input current at maximum input voltage	V_{CC} = MAX, V_I = 7.0V					100	µA
I_{IH}	High-level input current	V_{CC} = MAX, V_I = 2.7V					20	µA
I_{IL}	Low-level input current	V_{CC} = MAX, V_I = 0.5V					−0.6	mA
I_{OS}	Short-circuit output current[3]	V_{CC} = MAX			−100		−225	mA
I_{CC}	Supply current (total)	I_{CCH}	V_{CC} = MAX	V_{IN} = GND		1.75	4.0	mA
		I_{CCL}		V_{IN} = 4.5V		11	17	

NOTES:
1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
2. All typical values are at V_{CC} = 5V, T_{amb} = 25°C.
3. Not more than one output should be shorted at a time. For testing I_{OS}, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

Dual 4-input NAND buffer

AC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITION	LIMITS					UNIT
			V_{CC} = +5.0V T_{amb} = +25°C C_L = 50pF, R_L = 500Ω			V_{CC} = +5.0V ± 10% T_{amb} = 0°C to +70°C C_L = 50pF, R_L = 500Ω		
			MIN	TYP	MAX	MIN	MAX	
t_{PLH} t_{PHL}	Propagation delay Dna, Dnb, Dnc, Dnd to $\overline{Q}n$	Waveform 1	2.0 1.5	4.0 3.0	6.0 5.0	1.5 1.0	7.0 5.5	ns

AC WAVEFORMS
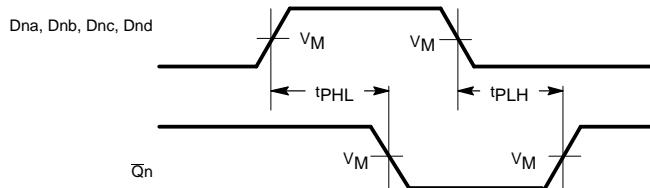
Waveform 1.   Propagation Delay for Inverting Outputs

NOTE:
For all waveforms, V_M = 1.5V.

TEST CIRCUIT AND WAVEFORMS

Test Circuit for Totem-Pole Outputs

DEFINITIONS:
R_L = Load resistor;
    see AC electrical characteristics for value.
C_L = Load capacitance includes jig and probe capacitance;
    see AC electrical characteristics for value.
R_T = Termination resistance should be equal to Z_{OUT} of
    pulse generators.
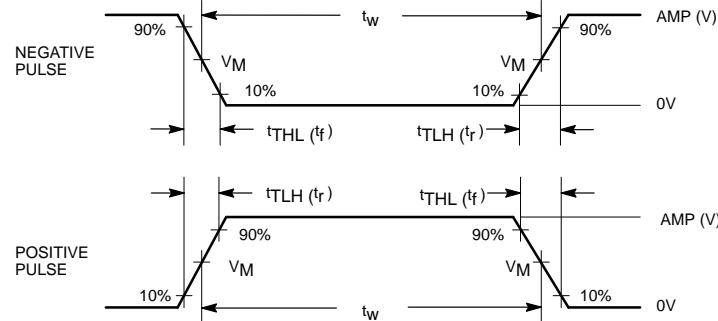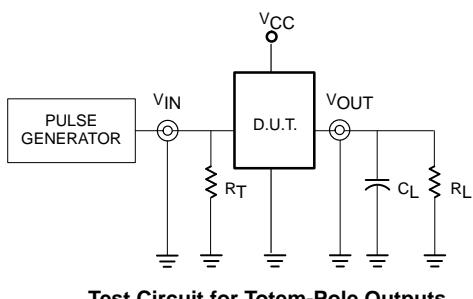
Input Pulse Definition

family	INPUT PULSE REQUIREMENTS					
	amplitude	V_M	rep. rate	t_w	t_{TLH}	t_{THL}
74F	3.0V	1.5V	1MHz	500ns	2.5ns	2.5ns